

Technical Data Sheet

HTE-5357 High Temperature Epoxy

High Temperature, Low Viscosity, Room Temperature Curing Potting Compound

Mix Ratio by Weight, resin : hardener	100:12	
Specific Gravity, gms/cc @25°C	1.58	
Mixed Viscosity, cP @25℃	16,000	
Pot Life, 100 gm mass @25 ℃, hrs	2	
Recommended Cure, hr/°F	4/RT 2/200	
Alternate Cure, hr/ °F	24-48/RT	
CURED PROPERTIES		
Temperature Resistance, °F	-67/+248	
Temperature Resistance, ℃	-55/+120	
CTE, in/in/ ^c F x 10 ⁻⁶ (^c C)	39.0 (70.2)	
Thermal Conductivity, Btu-in/hr-ft ² - °F	4.4	
Tensile Shear Strength, psi*1	1,135	
Flexural Strength, psi	14,100	
Volume Resistivity, ohms-cm	3.0×10^{15}	
Dielectric Strength, volts-mils	460	
Dielectric Constant, 1.0 kHz	4.8	
Dissipation Factor	.014	
Chemical Resistance	Excellent	
Hardness, Shore D	89	
Color	Black	
Cure Shrinkage, in/in* ²	.003	

*² Linear shrinkage is measured using a ³/₄ lb casting mass.

General Information

For safe handling information on this product, consult the Material Safety Data Sheet (MSDS).

Shelf Life

This product has a six months minimum shelf life after date of manufacture, unless otherwise specified, in original, unopened containers.

Note

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